



TCXO SPECIFICATION

Customer: _____
Customer P/N: _____
TKD P/N: TC20A026000GECN103
Part Name: SMD TCXO 2016
Product Description: 26.000000MHz
Issue Date: 2020/12/21

CUSTOMER'S APPROVAL

(PLEASE RETURN A COPY WITH APPROVAL)

TKD SCIENCE AND TECHNOLOGY CO.,LTD
泰晶科技股份有限公司

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REV.	Description of Revision History	Date	Designer	Checked By
A	New revision	2020/12/21	Zhan Chao	Zhong YuanHua



TCXO SPECIFICATION

- 1.Description** : 2016 TCXO
- 2.Nominal Frequency** : 26.000000MHz
- 3.Electrical Specifications** :

Item	Parameters		Condition	Electrical Specifications			
				MIN	TYP	MAX	UNITS
1	Nominal Frequency			26.000000			MHz
2	Frequency	Vs.Temperature (Note1)	@-30°C ~ 85°C	-0.5		0.5	ppm
			@-40°C ~ -30°C	-3.0		3.0	ppm
3	Stability	Vs.Load	±10%	-0.1		0.1	ppm
4		Vs.Supply Voltage	Standard Vcc±5%	-0.1		0.1	ppm
5	Operating Temperature Range			-40		85	°C
6	Frequency Tolerance		After 2 times reflow (Note2)	-2.0		2.0	ppm
7	Supply Voltage			1.68	1.80	3.08	Vcc
8	Current Consumption					2.0	mA
9	Output Level			0.8			V _{pp}
10	Output Waveform			Clipped Sine wave			
11	Standard Output Load			10kΩ // 10pF			
12	Duty Cycle			40	50	60	%
13	Hystersis			-0.5		0.5	ppm
14	Harmonics					-8.0	dBc
15	Aging		1 Year	-1.0		1.0	ppm
			2 Years	-1.5		1.5	ppm
			5 Years	-2.5		2.5	ppm
			10 Years	-5.0		5.0	ppm
16	Phase Noise	@1 Hz offset	Typical value at 25°C±5°C			-50	dBc/Hz
		@5 Hz offset				-73	dBc/Hz
		@10 Hz offset				-80	dBc/Hz
		@100 Hz offset				-106	dBc/Hz
		@1 kHz offset				-134	dBc/Hz
		@10 kHz offset				-145	dBc/Hz
		@100 kHz offset				-150	dBc/Hz
17	Frequency Slope (Note3)		@-20°C ~ 65°C	-0.05		0.05	ppm/°C
			@-30°C ~ 85°C	-0.1		0.1	ppm/°C
			@-40°C ~ -30°C	-0.35		0.35	ppm/°C
18	Storage Temperature			-40		85	°C

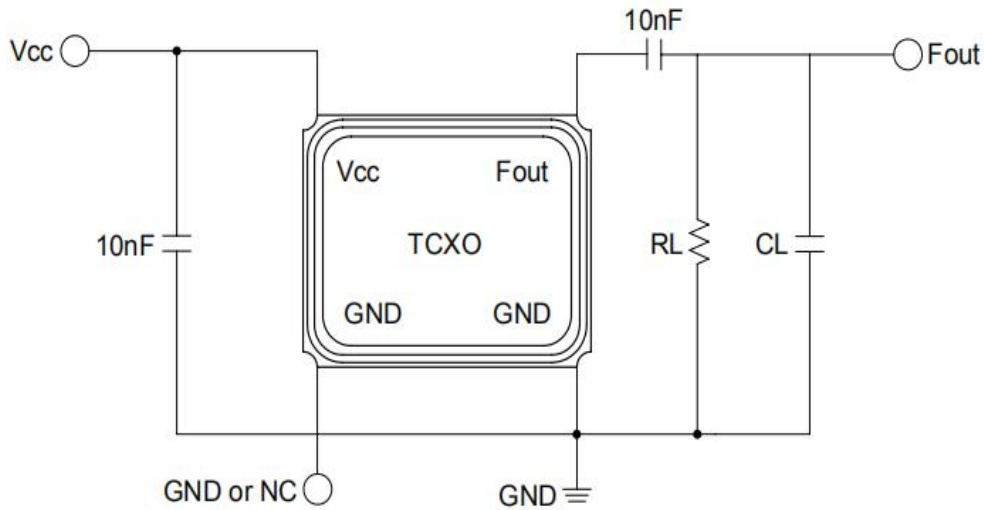
Note1 Refer to frequency at 25±2°C

Note2 Refer to nominal frequency

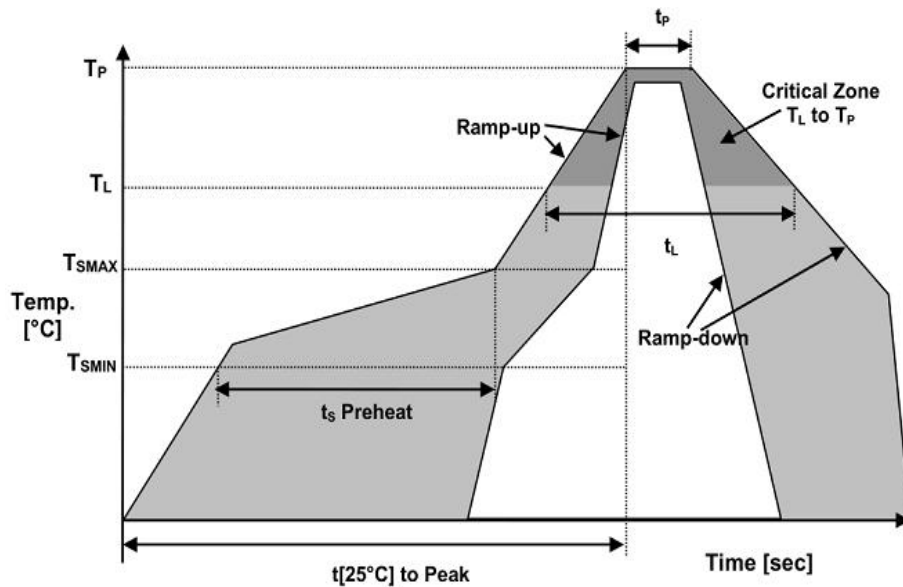
Note3 Temperature variation 2°C/step,from low to high



5.TEST CIRCUIT



6.RECOMMENDED REFLOW PROFILE

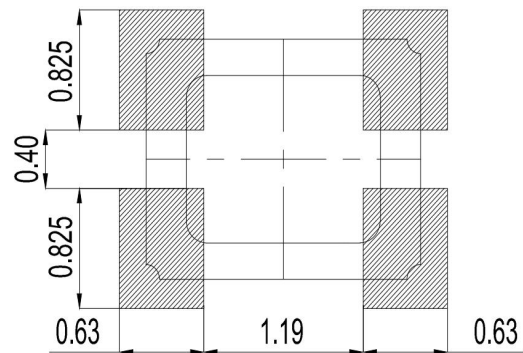
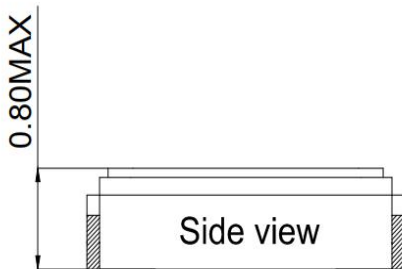
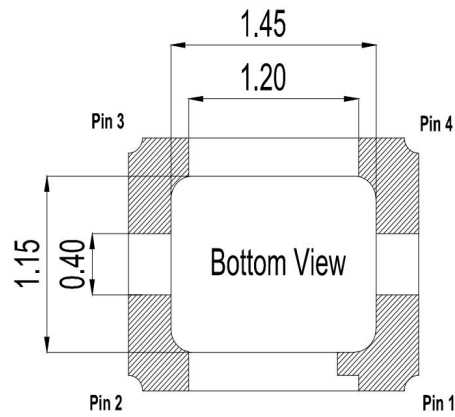
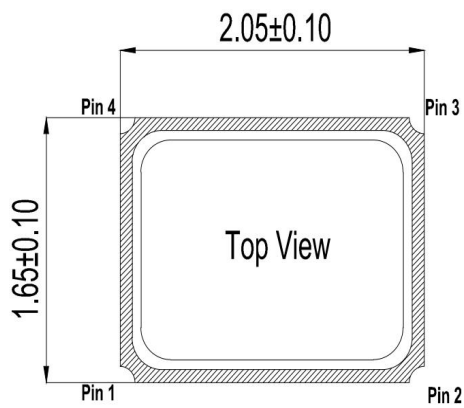


Reflow Profile		
Temperature MIN Preheat	T_{SMIN}	150°C
Temperature MAX Preheat	T_{SMAX}	200°C
Time ($T_{SMIN} - T_{SMAX}$)	t_s	60-180sec
Temperature	T_L	217°C
Peak Temperature	T_P	260°C
Ramp-up Rate	R_{UP}	3°C/sec max
Ramp-Down Rate	R_{DOWN}	6°C/sec max
Time within 5°C of Peak Temperature	t_p	10sec
Time $t[25°C]$ to Peak Temperature	$t[25°C]$ to Peak	480sec
Time	t_L	60-150sec



7.PRODUCT DIMENSIONS

Units: mm




PIN CONNECTION

Name	Connection
Pin 1	GND or NC
Pin 2	GND/Lid
Pin 3	Fout
Pin 4	Vcc



8.PRODUCT IDENTIFICATION (MARKING)

<p>26.00: Frequency Code</p> <p>●: Pin1 Index</p> <p>D: Date Code</p> <p>####: TCXO Lot Code</p>	
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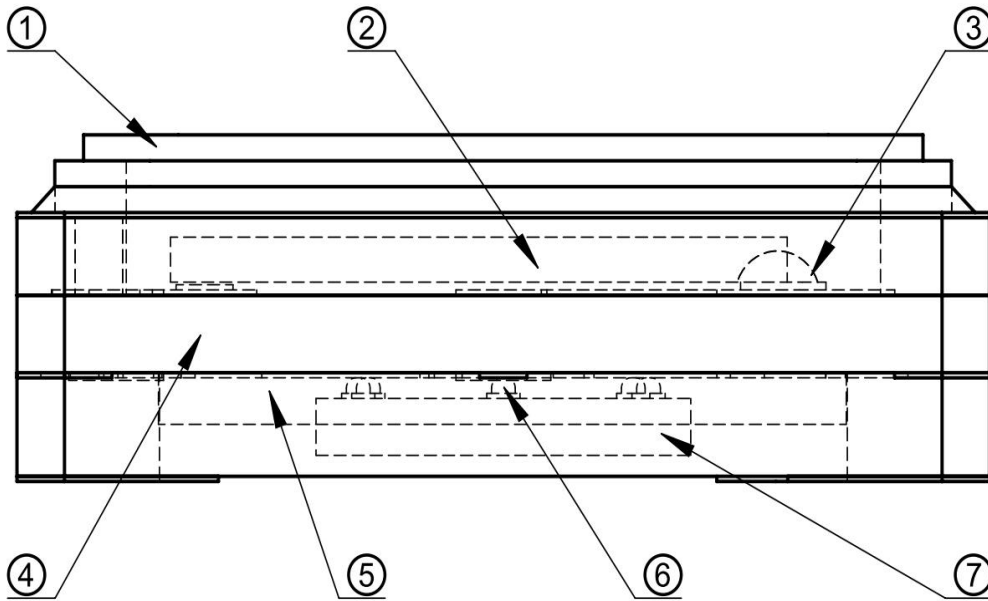
Date Code

Year		2019	2020	2021	2022
		2023	2024	2025	2026
		2027	2028	2029	2030
		2031	2032	2033	2034
Month	JAN	a	n	A	N
	FEB	b	p	B	P
	MAR	c	q	C	Q
	APR	d	r	D	R
	MAY	e	s	E	S
	JUN	f	t	F	T
	JUL	g	u	G	U
	AUG	h	v	H	V
	SEP	j	w	J	W
	OCT	k	x	K	X
	NOV	l	y	L	Y
	DEC	m	z	M	Z

※ This date code will be cycled every four years.



9.STRUCTURE ILLUSTRATION



No.	Components	Materials
①	Lid	Fe-Ni-Co Alloy
②	Crystal Blank	SiO ₂
③	Conductive Adhesive	Ag+Silicone resin
④	Base	Ceramic+Noble Metal
⑤	Underfill	Epoxy
⑥	Bump	Au
⑦	IC	Si



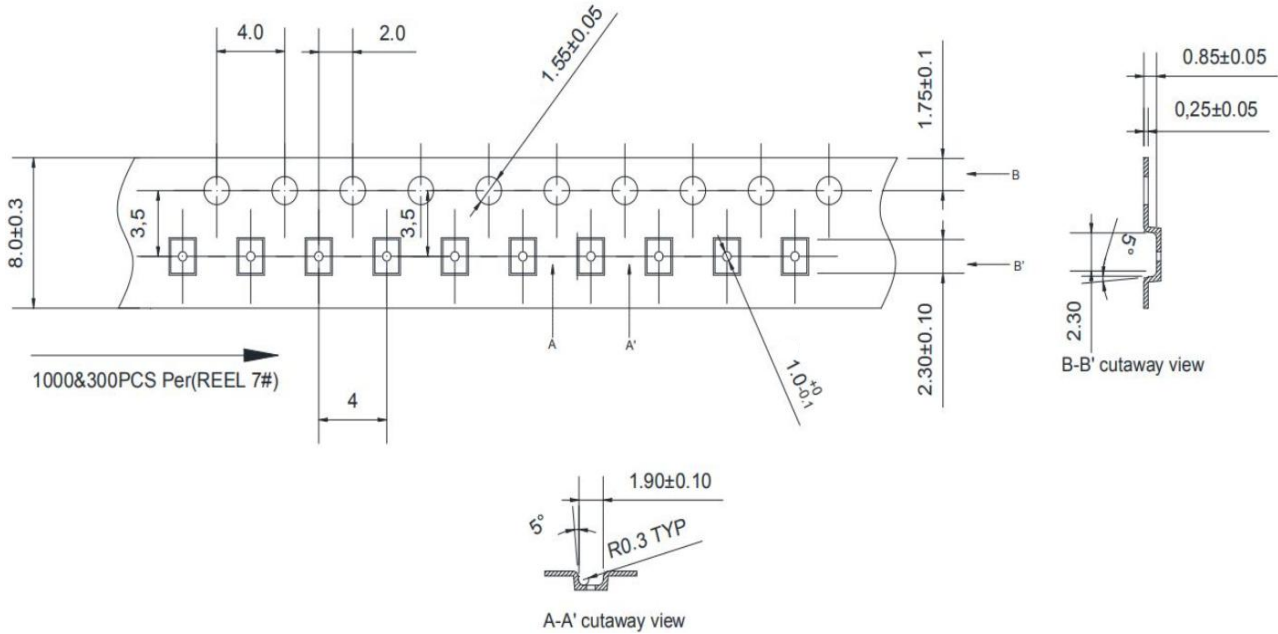
10.RELIABILITY

No.	Item	Test Methods	Criteria
1	High Temperature Storage	Temperature : 125°C ± 3°C Duration : 500 hours	±2.0 ppm
2	Low Temperature Storage	Temperature: -40°C ± 3°C Duration: 500 hours	±2.0 ppm
3	High temperature and humidity	Temperature: 85°C ± 2°C Humidity: RH 85% Duration: 500 hours	±2.0 ppm
4	Thermal Shock	<p>Duration: 500 cycles Temperature change within 3 minute</p>	±2.0 ppm
5	High Temperature Operating Life	Temperature : 85°C Duration: 500 hours Vdd Applied	±2.0 ppm
6	Vibration	Acceleration: 20 g Duration : 4 hours/each direction Frequency range: 55~2k Hz Direction: 3 axis	±2.0 ppm
7	Mechanical Shock	Acceleration: 1000 g Duration: 6.0 ms Test cycles: 3 times for all 6 axis, half sine	±2.0 ppm
8	Drop Test	Height: 100 cm Test cycles: 10 times With chucking (150g) , Marble	±2.0 ppm
9	Solderability	Soldering bath temperature: 245°C ± 5°C Duration: 3±0.3 second	90% Coated
10	Resistance to Soldering Heat	Soldering temperature: 260°C ± 5°C Duration: 10±1 second	±2.0 ppm
11	Board Flex	Height: 3.0 mm Duration: 5 second Speed: 0.5mm/sec	No peeling-off at a soldered part

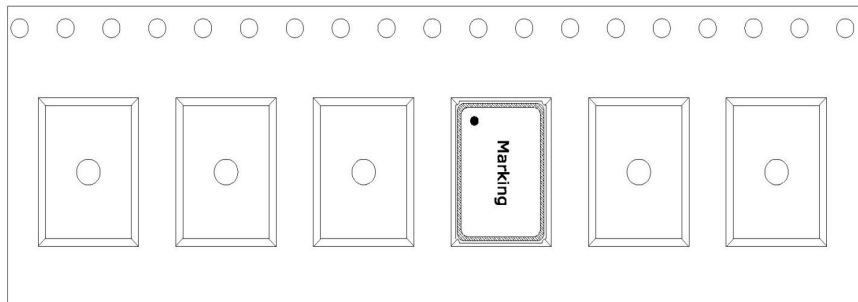


11.PACKAGE INFORMATION

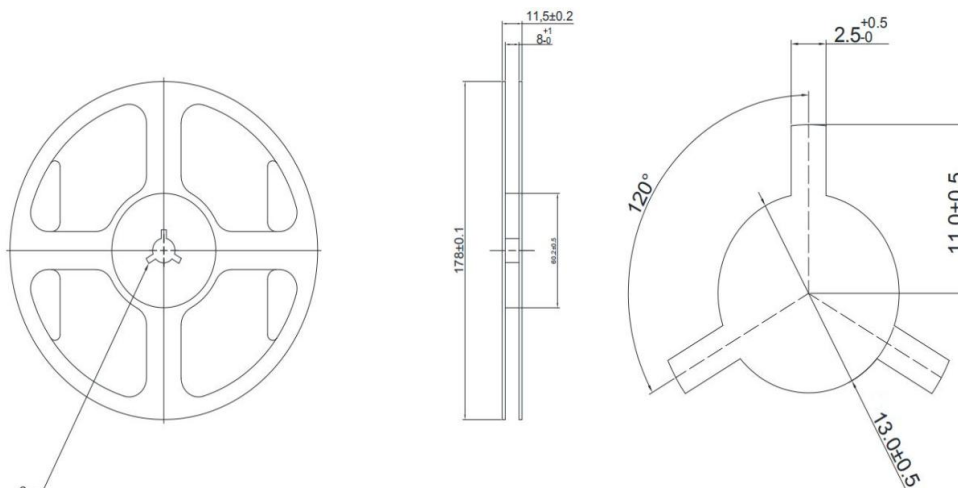
TAPE (CARRIER) DIMENSIONS



THE DIRECTION OF PACKING



REEL DIMENSIONS





Handling Instructions

1. Cautions for Handling

a) Prevention against electrostatic breakdown

Your full attention to static electricity is still requested.

b) Direction

Before mounting the crystal oscillator on board, Please confirm the direction to make sure the GND terminal and the terminal of power supply are not taken wrongly.

2. Prevention against Vibration and Shock

While the product is being transported or mounted onto board, if undue hock and vibration exceeding the specification is put on, there is risk hat the built-in crystal blank is broken.

When undue shock and vibration exceeding the specification is put on the product, please be sure to make confirmation of the product's characteristics.

3. Soldering

In order to assure the reliability of the crystal oscillator, please use the product under the recommended conditions.

4. Surface mounting

a) This product is surface-mounting device.

So, Please pay attention to the following things.

b) Extreme deformation of board may make pattern off, the electrode of terminals off and solder broken. Full attention is requested especially when splitting the board with the oscillator mounted where the camber of the board occurs.

c) In case that automatic mounter is used, please choose the type with small shock generation and make confirmation of the shock before use.

5. Cleaning

Because cleaning will cause change to all characteristics, cleaning is forbidden.

6. Store keeping (method and duration)

Long-time storage in the high/low temperature and high humidity leads to deterioration of solderability. So, please keep the product in the temperature of +5~+35 and humidity of 45~70%.

Moreover, please keep the product in the circumstance with measures against static electricity.

The storage life is 6 months before the pack is opened and please use it within 168 hours after the pack is opened.

(Please keep it with desiccator etc. when you exceed 168 hours after the bag is opened. Please use it after confirming the product solderability.)

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